

## N-Channel 100-V (D-S) MOSFET

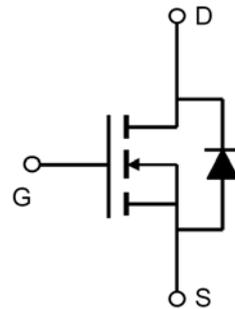
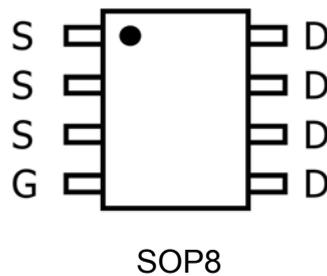
### ● FEATURES

$V_{DS}$	100V
$I_D$ ( $V_{GS}=10V$ )	3.6A
$R_{DS(ON)}$ ( $V_{GS}=10V$ )	<120m $\Omega$
$R_{DS(ON)}$ ( $V_{GS} = 4.5V$ )	<145m $\Omega$

### ● GENERAL DESCRIPTION

The FS4460 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is ideal for load switch and battery protection applications.

### ● PIN CONFIGURATION



### ● Absolute Maximum Ratings ( $T_A=25^{\circ}C$ unless otherwise noted)

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		$V_{DS}$	100	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_A=25^{\circ}C$	$I_D$	3.6	A
	$T_A=70^{\circ}C$		2.9	
Pulsed Drain Current <sup>C</sup>		$I_{DM}$	14	
Avalanche Current <sup>C</sup>		$I_{AS}, I_{AR}$	22	A
Avalanche energy $L=0.1mH$ <sup>C</sup>		$E_{AS}, E_{AR}$	18	mJ
Power Dissipation <sup>B</sup>	$T_A=25^{\circ}C$	$P_D$	3.1	W
	$T_A=70^{\circ}C$		2	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55 to 150	$^{\circ}C$

● **Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	100			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$			1	$\mu\text{A}$
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1		3	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=3.6\text{A}$		95	120	m $\Omega$
		$V_{GS}=4.5\text{V}, I_D=3.6\text{A}$		110	145	
$V_{SD}$	Diode Forward Voltage	$I_S=2.3\text{A}, V_{GS}=0\text{V}$		0.8	1.2	V
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		905		pF
$C_{oss}$	Output Capacitance			145		
$C_{rss}$	Reverse Transfer Capacitance			43		
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		1		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=80\text{V}, I_D=2.5\text{A}$		24		nC
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=80\text{V}, I_D=2.5\text{A}$		14		
$Q_{gs}$	Gate Source Charge			3.8		
$Q_{gd}$	Gate Drain Charge			7.5		
$t_{D(on)}$	Turn-On Delay Time	$V_{DD}=50\text{V}, R_L=10\Omega, I_D=1\text{A}, V_{GEN}=10\text{V}, R_G=6\Omega$		15		ns
$t_r$	Turn-On Rise Time			8		
$t_{D(off)}$	Turn-Off Delay Time			47		
$t_f$	Turn-Off Fall Time			6		

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^\circ\text{C}$ , using  $\leq 10\text{s}$  junction-to-ambient thermal resistance.

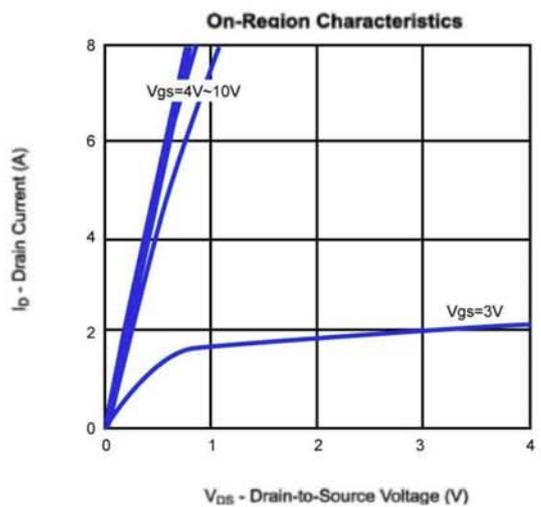
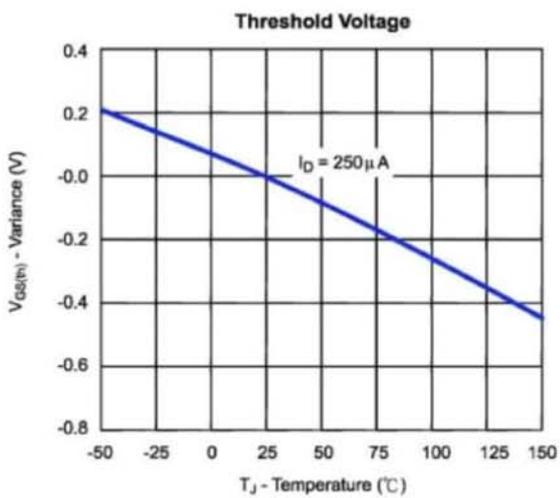
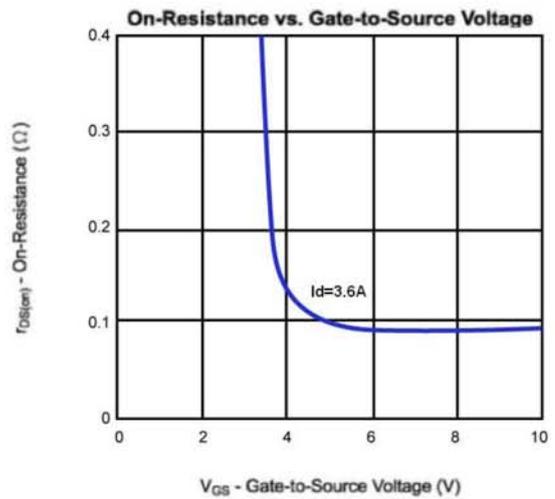
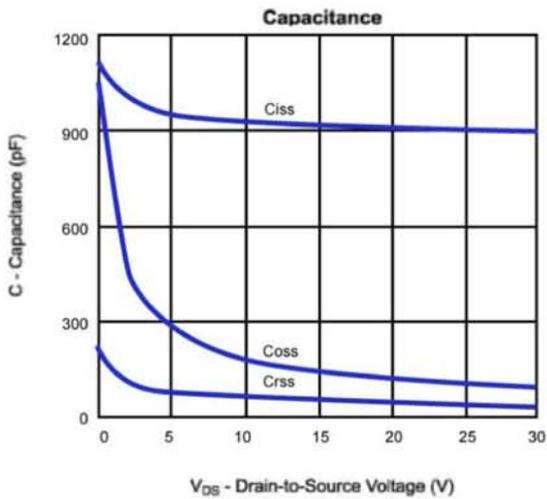
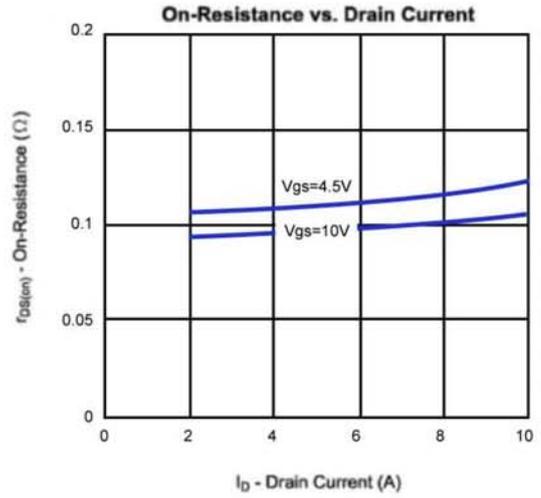
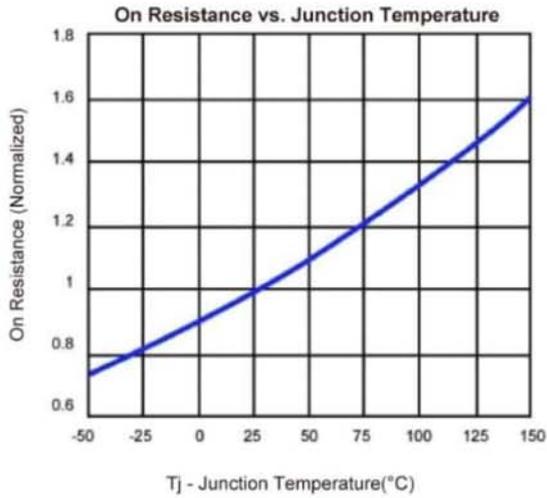
C. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.

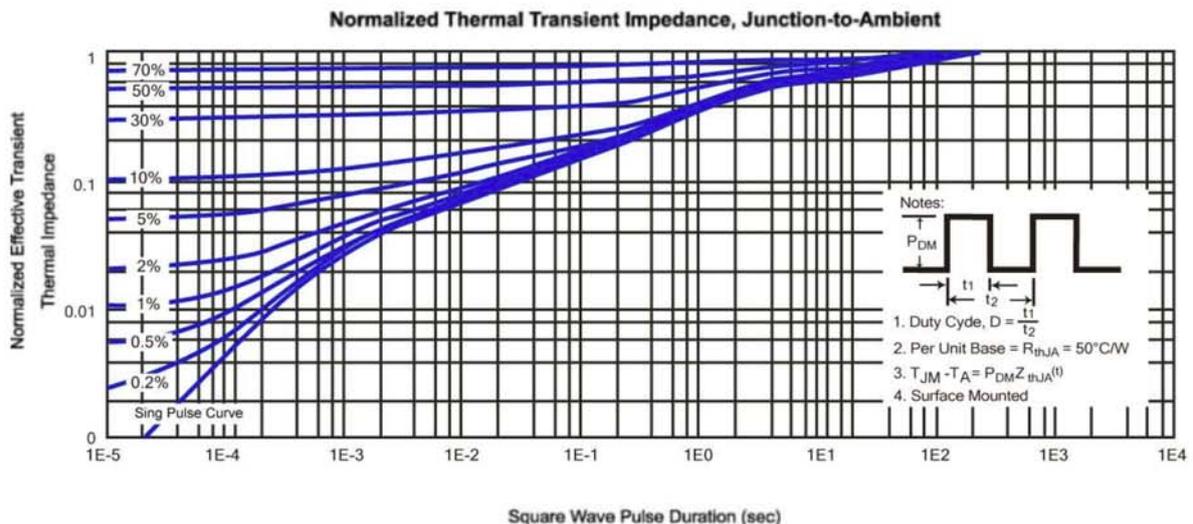
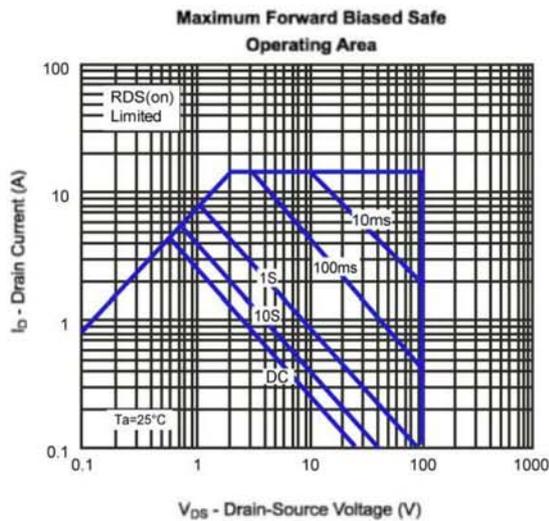
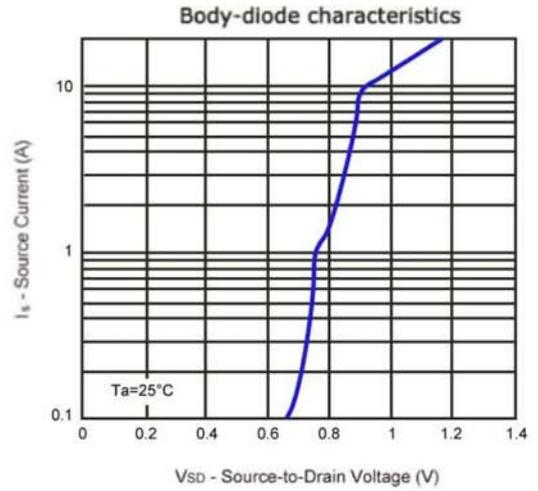
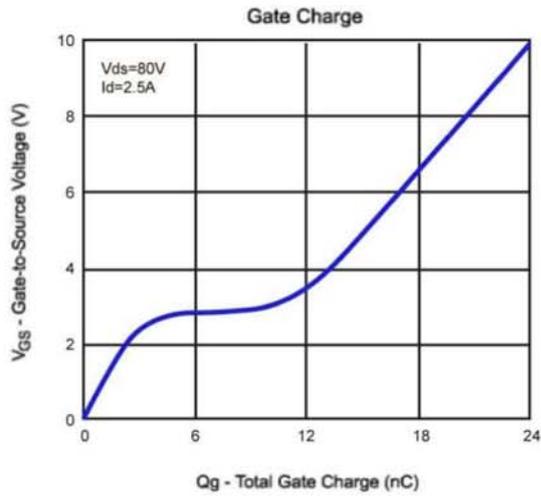
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(MAX)}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



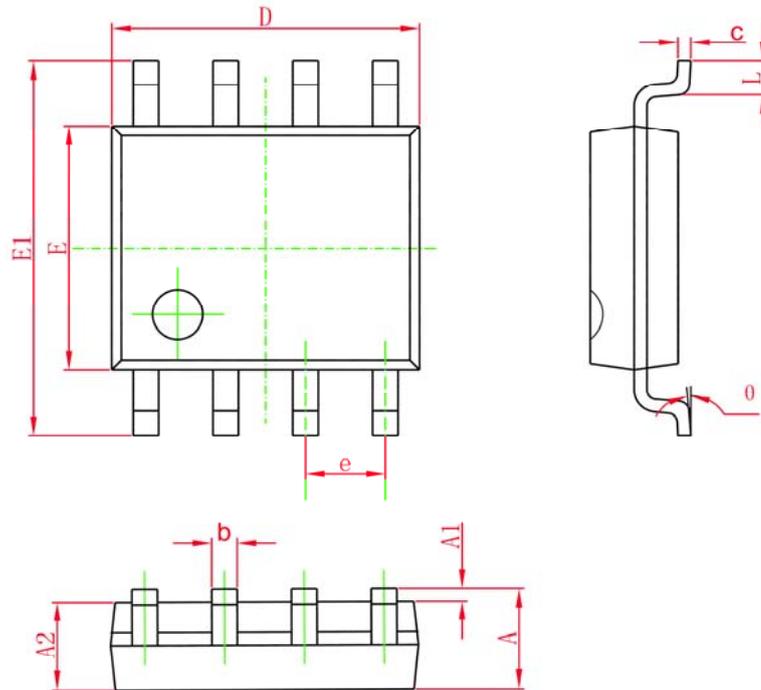
# FS4460

## ● TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



- Package Information

## SOP8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°